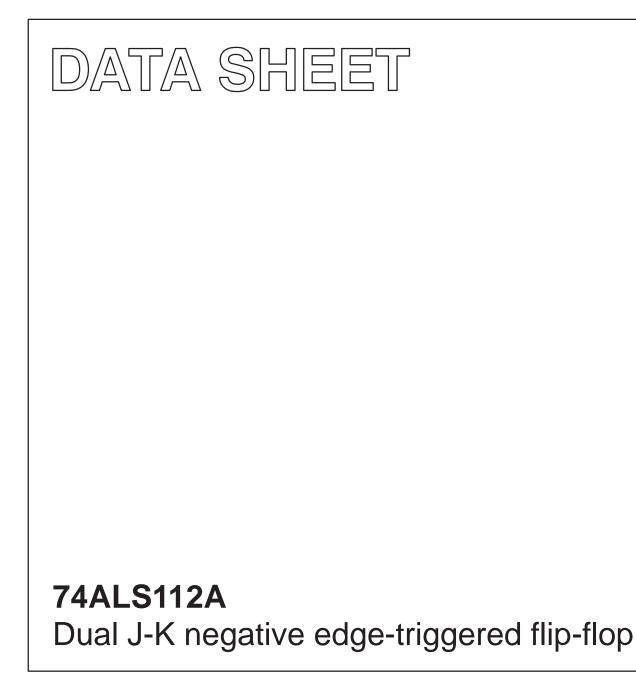
INTEGRATED CIRCUITS



Product specification IC05 Data Handbook

1996 June 27



Philips Semiconductors

74ALS112A

DESCRIPTION

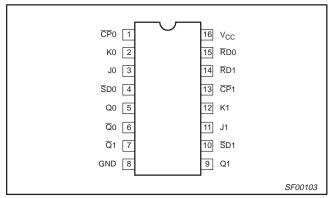
The 74ALS112A, dual negative edge-triggered JK-type flip-flop features individual J, K, clock (\overline{CPn}), set (\overline{SD}), and reset (\overline{RD}) inputs, true (Qn) and complementary (\overline{Qn}) outputs.

The \overline{SD} and \overline{RD} inputs, when Low, set or reset the outputs as shown in the function table regardless of the level at the other inputs.

A High level on the clock (\overline{CPn}) input enables the J and K inputs and data will be accepted. The logic levels at the J and K inputs may be allowed to change while the \overline{CPn} is High and the flip-flop will perform according to the function table as long as minimum setup and hold times are observed. Output changes are initiated by the High-to-Low transition of the \overline{CPn} .

TYPE	TYPICAL f _{MAX}	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS112A	50MHz	3.0mA

PIN CONFIGURATION



ORDERING INFORMATION

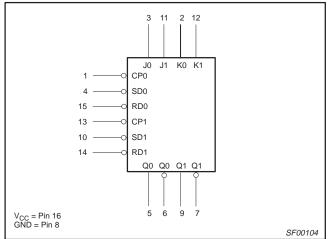
	ORDER CODE		
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V ±10%, T_{amb} = 0°C to +70°C	DRAWING NUMBER	
16-pin plastic DIP	74ALS112AN	SOT38-4	
16-pin plastic SO	74ALS112AD	SOT109-1	

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

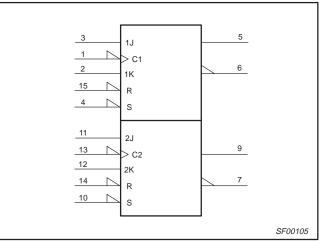
PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
CP0, CP1	Clock Pulse input (active falling edge)	1.0/1.0	20µA/0.1mA
J0, J1	J inputs	1.0/2.0	20µA/0.2mA
K0, K1	K inputs	1.0/2.0	20µA/0.2mA
SD0, SD1	Set inputs (active-Low)	1.0/2.0	20µA/0.2mA
RD0, RD1	Reset inputs (active-Low)	1.0/2.0	20µA/0.2mA
Q0, Q1, Q0, Q1	Data outputs	20/80	0.4mA/8mA

NOTE: One (1.0) ALS unit load is defined as: 20µA in the High state and 0.1mA in the Low state.

LOGIC SYMBOL

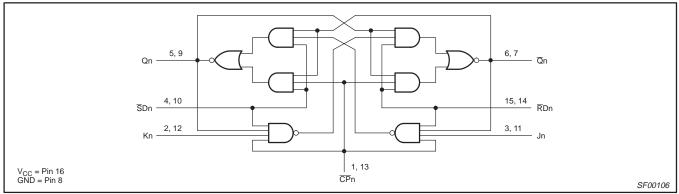


IEC/IEEE SYMBOL



74ALS112A

LOGIC DIAGRAM



FUNCTION TABLE

		INPUTS			OUTI	OPERATING MODE	
SD	RD	CP	J	к	Q	Q	OFERATING MODE
L	Н	Х	Х	Х	Н	L	Asynchronous Set
Н	L	Х	Х	Х	L	Н	Asynchronous Reset
L	L	Х	Х	Х	H*	H*	Undetermined *
Н	Н	\downarrow	h	h	q	q	Toggle
Н	Н	\downarrow	h	I	Н	L	Load "1" (Set)
Н	Н	\downarrow	I	h	L	Н	Load "0" (Reset)
Н	Н	\downarrow	I	I	q	q	Hold "no change"
Н	Н	Н	Х	Х	q	q	Hold "no change"

H =

High voltage level High state must be present one setup time prior to High-to-Low clock transition h =

Low voltage level L =

L =

Low state must be present one setup time prior to High-to-Low clock transition Lower case indicate the state of the referenced output prior to the High-to-Low clock transition =

q X = Don't care

 \downarrow = High-to-Low clock transition

* Both outputs will be High while both SD and RD are Low, but the output states are unpredictable if SD and RD go High simultaneously = Asynchronous inputs: Low input to SD sets Q to High level, Low input to RD sets Q to Low level. Set and reset are independent of clock. Simultaneous Low on both SD and RD makes both Q and Q High.

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ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	-30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	–0.5 to V _{CC}	V
I _{OUT}	Current applied to output in Low output state	16	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT		
STWBOL	PARAMETER	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
l _{lk}	Input clamp current			-18	mA
I _{OH}	High-level output current			-0.4	mA
I _{OL}	Low-level output current			8	mA
T _{amb}	Operating free-air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMPOL	PARAMETER		TEST CONDITI			LIMITS		UNIT
SYMBOL	PARAMETER			TEST CONDITIONS ¹			MAX	UNIT
V _{OH}	High-level output voltage		$ \begin{array}{l} V_{CC} = \pm 10\%, \\ V_{IL} = MAX, \ V_{IH} = MIN \end{array} $	$I_{OH} = -0.4 \text{mA}$	V _{CC} – 2			V
V			$V_{CC} = MIN, V_{IL} = MAX,$	$I_{OL} = 4mA$		0.25	0.40	V
V _{OL}	Low-level output voltage		V _{IH} = MIN	I _{OL} = 8mA		0.35	0.50	V
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.5	V
lı –	Input current at maximum input	voltage	$V_{CC} = MAX, V_I = 7.0V$				0.1	mA
IIH	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μA
		CPn					-0.1	mA
I _{IL}	Low-level input current SDn, RDn, Jn, Kn		$V_{CC} = MAX, V_I = 0.4V$				-0.2	mA
Ι _Ο	Output current ³		$V_{CC} = MAX, V_O = 2.25V$		-30		-112	mA
Icc	Supply current (total)		V _{CC} = MAX			2.5	4.5	mA

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2. All typical values are at $V_{CC} = 5V$, $T_{amb} = 25^{\circ}C$. 3. The output conditions have been chosen to produce a current that closely approximates one half of the true short–circuit output current, I_{OS} .

AC ELECTRICAL CHARACTERISTICS

			LIM	ITS	
SYMBOL	PARAMETER	TEST CONDITION	T _{amb} = 0°C V _{CC} = +5. C _L = 50pF,	UNIT	
			MIN	MAX]
f _{MAX}	Maximum clock frequency	Waveform 1	35		MHz
t _{PLH} t _{PHL}	Propagation delay CPn to Qn or Qn	Waveform 1	2.0 4.0	10.0 10.5	ns
t _{PLH} t _{PHL}	Propagation delay SDn or RD to Qn or Qn	Waveform 2, 3	1.5 3.5	8.0 9.5	ns

AC SETUP REQUIREMENTS

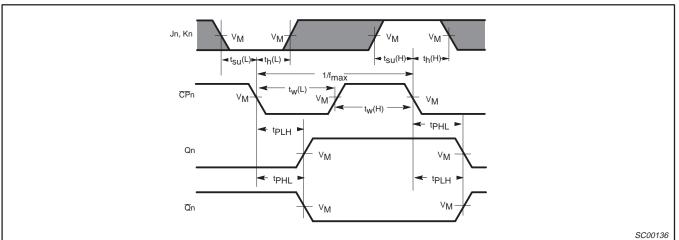
			LIM	ITS	
SYMBOL	PARAMETER	TEST CONDITION	T _{amb} = 0°0 V _{CC} = +5. C _L = 50pF,	C to +70°C 0V ± 10% R _L = 500Ω	UNIT
			MIN	MAX	
t _{su} (H) t _{su} (L)	Setup time, High or Low Jn, Kn to CPn	Waveform 1	8.0 8.0		ns
t _h (H) t _h (L)	Hold time, High or Low Jn, Kn to CPn	Waveform 1	0.0 0.0		ns
t _w (H) t _w (L)	CPn Pulse width high or Low	Waveform 1	11.0 8.0		ns
t _w (L)	SDn or RDn Pulse width Low	Waveform 2, 3	6.0		ns
t _{REC}	Recovery time, SDn or RDn to CPn	Waveform 2, 3	8.0		ns

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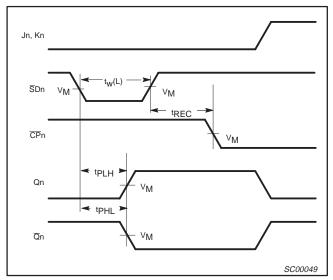
AC WAVEFORMS

For all waveforms, $V_M = 1.3V$.

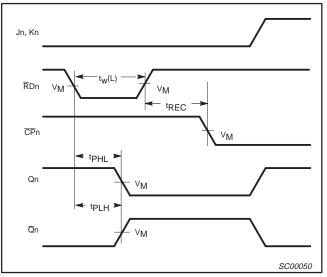
The sahded areas indicate when the input is permitted to change for predictable output performance.



Waveform 1. Propagation Delay for Data to Output, Data Setup Time and Hold Times, Clock Pulse Width, and Maximum Clock Frequency



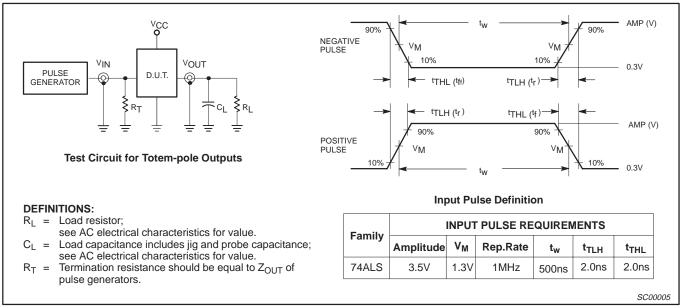
Waveform 2. Propagation Delay for Set to Output, Set Pulse Width, and Recovery Time for Set to Clock

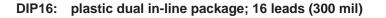


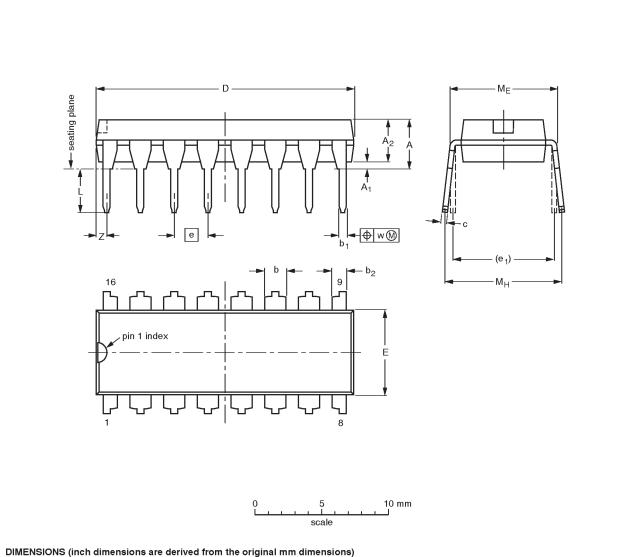
Waveform 3. Propagation Delay for Reset to Output, Reset Pulse Width, and Recovery Time for Reset to Clock

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TEST CIRCUIT AND WAVEFORMS







UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	с	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

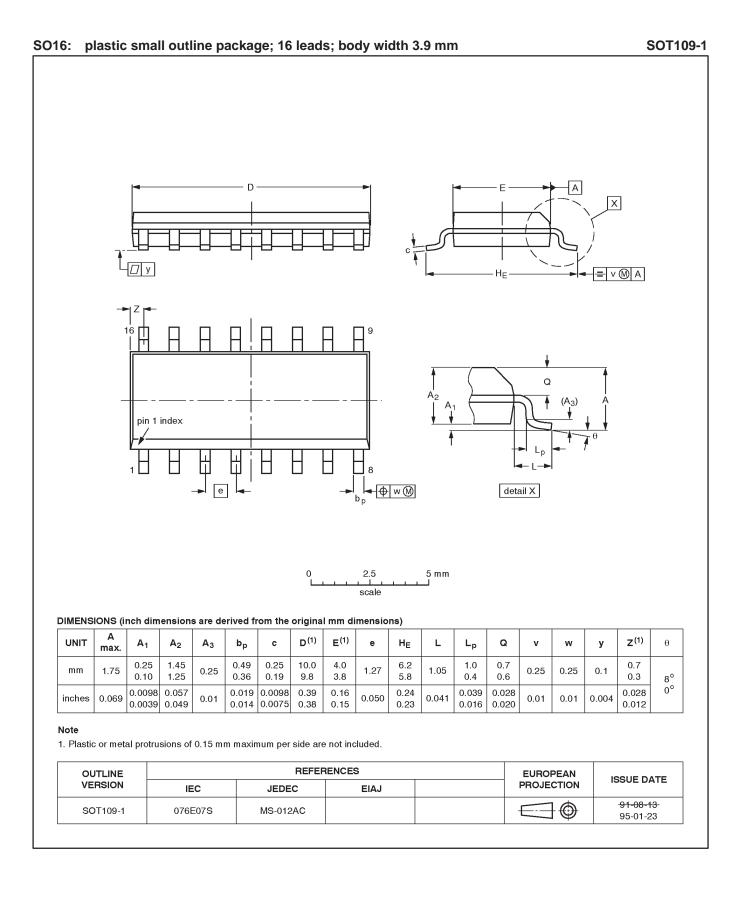
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT38-4						-92-11-17 95-01-14

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SOT38-4

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	DEFINITIONS						
Data Sheet Identification	Product Status	Definition					
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.					
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